## MM54C240,MM54C244,MM74C240,MM74C244

MM54C240 MM74C240 Inverting MM54C244 MM74C244 Non-Inverting Octal Buffers and Line Drivers with TRI-STATE(RM) Outputs



Literature Number: SNOS331A



## MM54C240/MM74C240 Inverting MM54C244/MM74C244 Non-Inverting Octal Buffers and Line Drivers with TRI-STATE® Outputs

## **General Description**

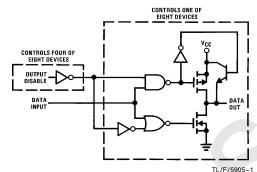
These octal buffers and line drivers are monolithic complementary MOS (CMOS) integrated circuits with TRI-STATE outputs. These outputs have been specially designed to drive highly capacitive loads such as bus-oriented systems. These devices have a fan out of 6 low power Schottky loads. A high logic level on the output disable control input G makes the outputs go into the high impedance state. For improved TTL input compatibility see MM74C941.

## **Features**

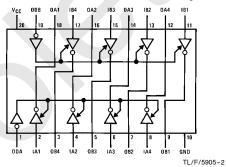
- Wide supply voltage range (3V to 15V)
- High noise immunity (0.45 V<sub>CC</sub> typ)
- Low power consumption
- High capacitive load drive capability
- TRI-STATE outputs
- Input protection
- TTL compatibility
- 20-pin dual-in-line package
- High speed 25 ns (typ.) @ 10V, 50 pF (MM74C244)

## **Logic and Connection Diagrams**

### MM54C240/MM74C240



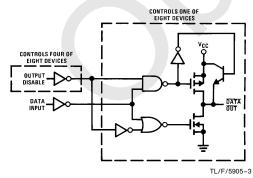
## MM54C240/MM74C240 Dual-In-Line Package



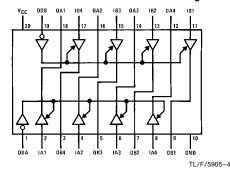
Top View

Order Number MM54C240 or MM74C240

## MM54C244/MM74C244



## MM54C244/MM74C244 Dual-In-Line Package



Top View

Order Number MM54C244 or MM74C244

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## Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Voltage at Any Pin  $-0.3 \mbox{V to V}_{\mbox{CC}} + 0.3 \mbox{V}$ 

Operating Temperature Range MM54C240, MM54C244 -55°C to +125°C

MM74C240, MM74C244  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$  Storage Temperature Range

 $-65^{\circ}\text{C}$  to  $+150^{\circ}\text{C}$ 

Power Dissipation

Dual-In-Line Small Outline 700 mW 500 mW

Operating V<sub>CC</sub> Range

3V to 15V

Absolute Maximum V<sub>CC</sub> Lead Temperature (Soldering, 10 seconds)

18V 260°C

DC Electrical Characteristics Min/Max limits apply across temperature range, unless otherwise noted

Symbol	Parameter	Conditions	Min	Тур	Max	Units
смоѕ то сі	MOS					
V <sub>IN(1)</sub>	Logical "1" Input Voltage	$V_{CC} = 5V$ $V_{CC} = 10V$	3.5 8.0			V V
V <sub>IN(0)</sub>	Logical "0" Input Voltage	$V_{CC} = 5V$ $V_{CC} = 10V$			1.5 2.0	V
V <sub>OUT(1)</sub>	Logical "1" Output Voltage	$V_{CC} = 5V$ , $I_{O} = -10 \mu A$ $V_{CC} = 10V$ , $I_{O} = -10 \mu A$	4.5 9.0			V V
V <sub>OUT(0)</sub>	Logical "0" Output Voltage	$V_{CC} = 5V$ , $I_O = 10 \mu A$ $V_{CC} = 10V$ , $I_O = 10 \mu A$			0.5 1.0	V V
loz	TRI-STATE Output Current	$V_{CC} = 10V, OD = V_{IH}$			±10	μΑ
I <sub>IN(1)</sub>	Logical "1" Input Current	V <sub>CC</sub> = 15V, V <sub>IN</sub> = 15V		0.005	1.0	μΑ
I <sub>IN(0)</sub>	Logical "0" Input Current	$V_{CC} = 15V, V_{IN} = 0V$	-1.0	-0.005		μΑ
Icc	Supply Current	V <sub>CC</sub> = 15V		0.05	300	μΑ
MOS/LPTT	L INTERFACE					
V <sub>IN(1)</sub>	Logical "1" Input Voltage	54C, V <sub>CC</sub> = 4.5V 74C, V <sub>CC</sub> = 4.75V	V <sub>CC</sub> - 1.5 V <sub>CC</sub> - 1.5			V V
V <sub>IN(0)</sub>	Logical "0" Input Voltage	54C, V <sub>CC</sub> = 4.5V 74C, V <sub>CC</sub> = 4.75V			0.8 0.8	V V
V <sub>OUT(1)</sub>	Logical "1" Output Voltage	54C, $V_{CC} = 4.5V$ , $I_{O} = -450 \mu A$ 74C, $V_{CC} = 4.75V$ , $I_{O} = -450 \mu A$	V <sub>CC</sub> - 0.4 V <sub>CC</sub> - 0.4			V V
		54C, $V_{CC} = 4.5V$ , $I_{O} = -2.2$ mA 74C, $V_{CC} = 4.75V$ , $I_{O} = -2.2$ mA	2.4 2.4			V V
V <sub>OUT(0)</sub>	Logical "0" Output Voltage	$54C$ , $V_{CC} = 4.5V$ , $I_{O} = 2.2$ mA $74C$ , $V_{CC} = 4.75V$ , $I_{O} = 2.2$ mA			0.4 0.4	V V
OUTPUT DR	IVE (See 54C/74C Family Char	acteristics Data Sheet) (Short Circuit	Current)			
ISOURCE	Output Source Current (P-Channel)	$V_{CC} = 5V$ , $V_{OUT} = 0V$ $T_A = 25$ °C	-14	-30		mA
		$V_{CC} = 10V$ , $V_{OUT} = 0V$ $T_A = 25$ °C	-36	-70		mA
ISINK	Output Sink Current (N-Channel)	$V_{CC} = 5V$ , $V_{OUT} = V_{CC}$ $T_A = 25$ °C	12	20		mA
		$V_{CC} = 10V, V_{OUT} = V_{CC}$ $T_A = 25$ °C	48	70		mA

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. Except for "Operating Range" they are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

Symbol	Parameter	Conditions	Min	Тур	Max	Units
t <sub>PD(1)</sub> , t <sub>PD(0)</sub>	Propagation Delay (Data In to Out)					
	MM54C240/MM74C240	$V_{CC} = 5V, C_{L} = 50 \text{ pF}$		60	90	ns
		$V_{CC} = 10V, C_L = 50 pF$		40	70	ns
		$V_{CC} = 5V, C_L = 150  pF$		80	110	ns
		$V_{CC} = 10V, C_L = 150  pF$		60	90	ns
	MM54C244/MM74C244	$V_{CC} = 5V, C_{L} = 50 \text{ pF}$		45	70	ns
		$V_{CC} = 10V, C_L = 50 pF$		25	50	ns
		$V_{CC} = 5V, C_L = 150  pF$		60	90	ns
		$V_{CC} = 10V, C_L = 150 pF$		40	70	ns
t <sub>1H</sub> , t <sub>0H</sub>	Propagation Delay Output	$R_L = 1k, C_L = 50 pF$				
	Disable to High Impedance	$V_{CC} = 5V$		45	80	ns
	State (from a Logic Level)	$V_{CC} = 10V$		35	60	ns
t <sub>H1</sub> , t <sub>H0</sub>	Propagation Delay Output	$R_{L} = 1k, C_{L} = 50 pF$				
	Disable to Logic Level	$V_{CC} = 5V$		50	90	ns
	(from High Impedance State)	V <sub>CC</sub> = 10V		30	60	ns
t <sub>T(HL)</sub> , t <sub>T(LH)</sub>	Transition Time	$V_{CC} = 5V, C_L = 50 pF$		45	80	ns
. , . ,		$V_{CC} = 10V, C_{L} = 50 pF$		30	60	ns
		$V_{CC} = 5V, C_L = 150  pF$		75	140	ns
		$V_{CC} = 10V, C_L = 150 pF$		50	100	ns
C <sub>PD</sub>	Power Dissipation Capacitance (Output Enabled per Buffer)	(Note 3)				
	MM54C240/MM74C240			100		pF
	MM54C244/MM74C244			100		pF
	(Output Disabled per Buffer) MM54C240/MM74C240			10		pF
	MM54C244/MM74C244			0		pF
C <sub>IN</sub>	Input Capacitance (Any Input)	$V_{IN} = 0V, f = 1 \text{ MHz}, T_A = 25^{\circ}\text{C}$		10		pF
Co	Output Capacitance (Output Disabled)	$V_{IN} = 0V, f = 1 \text{ MHz}, T_A = 25^{\circ}\text{C}$		10		pF

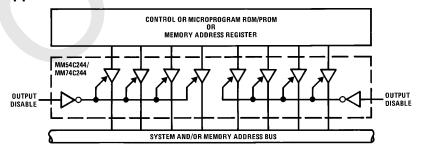
<sup>\*</sup>AC Parameters are guaranteed by DC correlated testing.

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. Except for "Operating Range" they are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

Note 2: Capacitance is guaranteed by periodic testing.

Note 3: C<sub>PD</sub> determines the no load AC power consumption of any CMOS device. For complete explanation see 54C/74C Family Characteristics Application Note, AN-90.

## **Typical Application**



TL/F/5905-5

## **Truth Tables**

### MM54C240/MM74C240

ODA	IA	OA
1	Х	Z
1	X	Z
0	0	1
0	1	0

ODB	IB	ОВ
1	Х	Z
1	Х	Z
0	0	1
0	1	0

## MM54C244/MM74C244

ODA	IA	OA
1	Х	Z
1	X	Z
0	0	0
0	1	1

1 = High

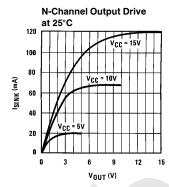
0 = Low

X = Don't Care

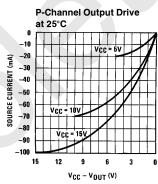
Z = TRI-STATE

# ODB IB OB 1 X Z 1 X Z 0 0 0 0 0 1 1 1 1

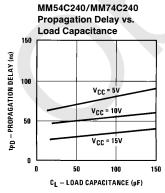
## **Typical Performance Characteristics**



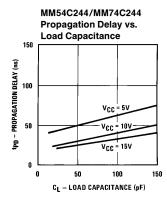
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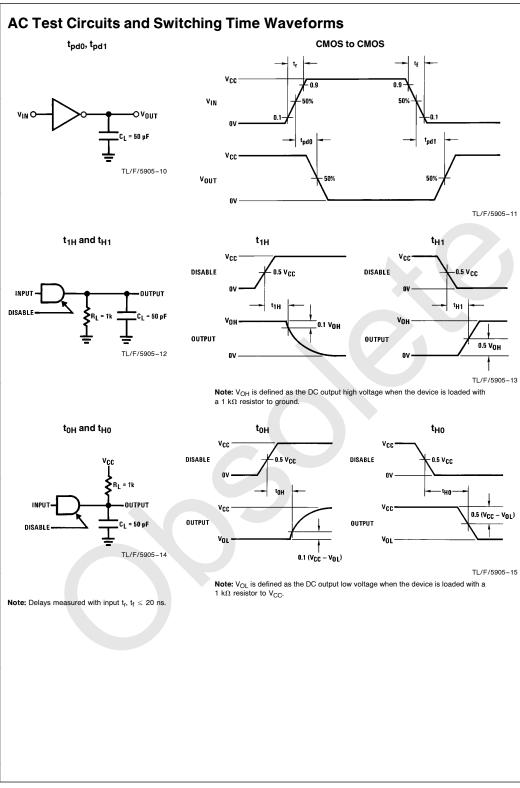
TL/F/5905-7

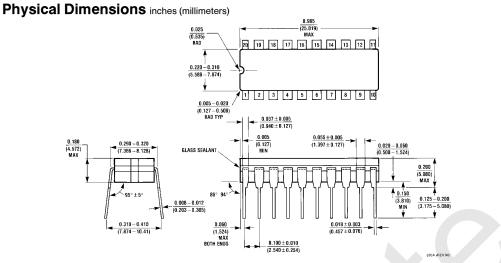


TL/F/5905-8

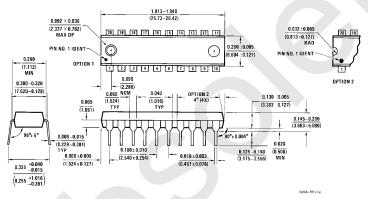


TL/F/5905-9





Ceramic Dual-In-Line Package (J) Order Number MM54C240J, MM54C244J, MM74C240J or MM74C244J See NS Package Number J20A



Molded Dual-In-Line Package (N) Order Number MM54C240N, MM54C244N, MM74C240N or MM74C244N See NS Package Number N20A

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